

## LF156JAN JFET Input Operational Amplifiers

Check for Samples: [LF156JAN](#)

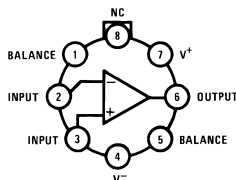
### FEATURES

- **Advantages**
  - Replace Expensive Hybrid and Module FET Op Amps
  - Rugged JFETs Allow Blow-Out Free Handling Compared with MOSFET Input Devices
  - Excellent for Low Noise Applications using either High or Low Source Impedance—Very Low  $1/f$  Corner
  - Offset Adjust does not Degrade Drift or Common-Mode Rejection as in Most Monolithic Amplifiers
  - New Output Stage Allows use of Large Capacitive Loads (5,000 pF) without Stability Problems
  - Internal Compensation and Large Differential Input Voltage Capability

### APPLICATIONS

- Precision High Speed Integrators
- Fast D/A and A/D Converters
- High Impedance Buffers
- Wideband, Low Noise, Low Drift Amplifiers
- Logarithmic Amplifiers
- Photocell Amplifiers
- Sample and Hold Circuits

### Connection Diagrams



**Figure 1. Top View  
Metal Can Package (LMC)  
See Package LMC0008C**

### COMMON FEATURES

- Low Input Bias Current: 30pA
- Low Input Offset Current: 3pA
- High Input Impedance:  $10^{12}\Omega$
- Low Input Noise Current:  $0.01 \text{ pA} / \sqrt{\text{Hz}}$
- High Common-Mode Rejection Ratio: 100 dB
- Large DC Voltage Gain: 106 dB

### UNCOMMON FEATURES

- Extremely Fast Settling Time to 0.01% 1.5 $\mu$ s
- Fast Slew Rate 12V/ $\mu$ s
- Wide Gain Bandwidth 5MHz
- Low Input Noise Voltage  $12 \text{ nV} / \sqrt{\text{Hz}}$

### DESCRIPTION

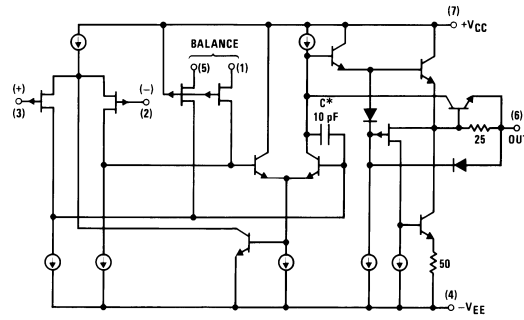
This is the first monolithic JFET input operational amplifier to incorporate well matched, high voltage JFETs on the same chip with standard bipolar transistors (BI-FET™ Technology). This amplifier features low input bias and offset currents/low offset voltage and offset voltage drift, coupled with offset adjust which does not degrade drift or common-mode rejection. The device is also designed for high slew rate, wide bandwidth, extremely fast settling time, low voltage and current noise and a low  $1/f$  noise corner.



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

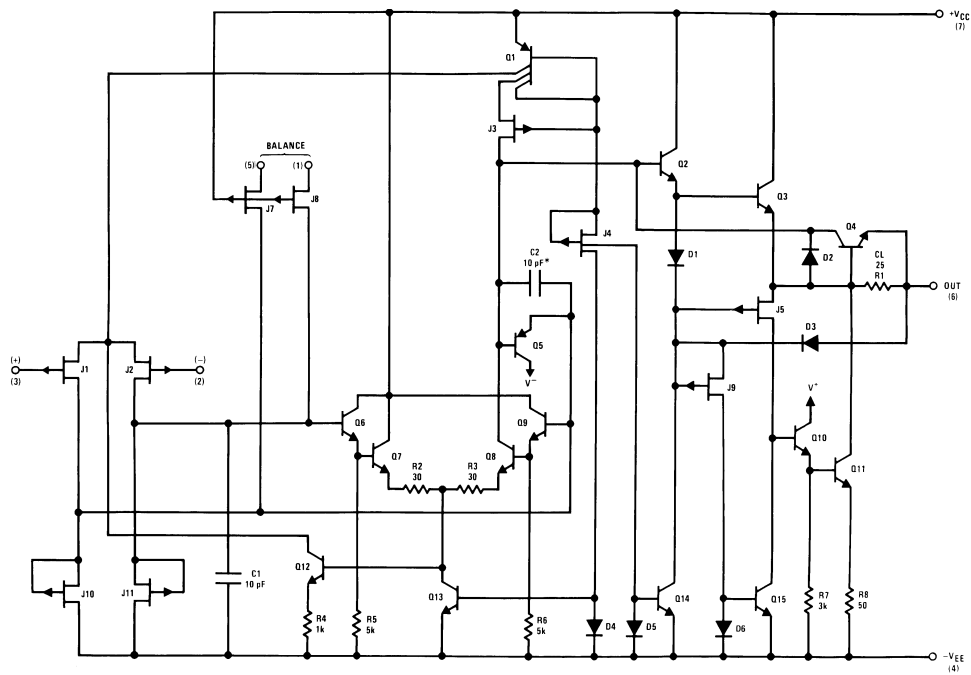
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**Simplified Schematic**



\*3pF in LF357 series.

**Detailed Schematic**



\*C = 3pF in LF357 series.



These devices have limited built-in ESD protection. The leads should be shorted together or the device placed in conductive foam during storage or handling to prevent electrostatic damage to the MOS gates.

**Absolute Maximum Ratings<sup>(1)</sup>**

Supply Voltage		±22V	
Differential Input Voltage		±40V	
Input Voltage Range <sup>(2)</sup>		±20V	
Output Short Circuit Duration <sup>(3)</sup>		Continuous	
T <sub>JMAX</sub>		175°C	
Power Dissipation at T <sub>A</sub> = 25°C <sup>(4)</sup>	Still Air	560 mW	
	500 LF/Min Air Flow	1200 mW	
Thermal Resistance	θ <sub>JA</sub>	Still Air	160°C/W
		400 LF/Min Air Flow	65°C/W
	θ <sub>JC</sub>		23°C/W
Storage Temperature Range		-65°C ≤ T <sub>A</sub> ≤ +150°C	
Lead Temperature (Soldering 10 sec.)		300°C	
ESD tolerance <sup>(5)</sup>		1200V	

- (1) Absolute Maximum Ratings indicate limits beyond which damage to the device may occur. Operating Ratings indicate condition for which the device is functional, but do not ensure specific performance limits. For specified specifications and test conditions, see the Electrical Characteristics. The ensured specifications apply only for the test conditions listed. Some performance characteristics may degrade when the device is not operated under the listed test conditions.
- (2) The absolute maximum negative input voltage is equal to the negative power supply voltage.
- (3) Short circuit may be to ground or either supply. Rating applies to +125°C case temperature or +75°C ambient temperature.
- (4) The maximum power dissipation must be derated at elevated temperatures and is dictated by T<sub>Jmax</sub> (maximum junction temperature), θ<sub>JA</sub> (package junction to ambient thermal resistance), and T<sub>A</sub> (ambient temperature). The maximum allowable power dissipation at any temperature is P<sub>D</sub> = (T<sub>Jmax</sub> - T<sub>A</sub>) / θ<sub>JA</sub> or the number given in the Absolute Maximum Ratings, whichever is lower.
- (5) Human body model, 100pF discharged through 1.5KΩ.

**Recommended Operating Conditions**

Supply voltage range	±5 to ±20 V <sub>DC</sub>
Ambient temperature range	-55°C ≤ T <sub>A</sub> ≤ +125°C

**Quality Conformance Inspection**

MIL-STD-883, Method 5005 - Group A

Subgroup	Description	Temp ( C)
1	Static tests at	+25
2	Static tests at	+125
3	Static tests at	-55
4	Dynamic tests at	+25
5	Dynamic tests at	+125
6	Dynamic tests at	-55
7	Functional tests at	+25
8A	Functional tests at	+125
8B	Functional tests at	-55
9	Switching tests at	+25
10	Switching tests at	+125
11	Switching tests at	-55
12	Settling time at	+25

### LF156 Electrical Characteristics DC Parameters

The following conditions apply, unless otherwise specified.

DC:  $V_{CC} = \pm 20V$ ,  $V_{CM} = 0V$

Symbol	Parameter	Conditions	Notes	Min	Max	Unit	Sub-groups
$I_{CC}$	Supply Current	$+V_{CC} = 15V, -V_{CC} = -15V$			7.0	mA	1
					6.0	mA	2
					11	mA	3
$V_{IO}$	Input Offset Voltage	$+V_{CC} = 5V, -V_{CC} = -35V, V_{CM} = 15V$		-5.0	5.0	mV	1
				-7.0	7.0	mV	2, 3
		$+V_{CC} = 35V, -V_{CC} = -5V, V_{CM} = -15V$		-5.0	5.0	mV	1
				-7.0	7.0	mV	2, 3
		$+V_{CC} = 5V, -V_{CC} = -5V$		-5.0	5.0	mV	1
				-7.0	7.0	mV	2, 3
$\pm I_{IB}$	Input Bias Current	$+V_{CC} = 5V, -V_{CC} = -35V, V_{CM} = 15V$		-0.1	3.5	nA	1
				-10	60	nA	2
		$+V_{CC} = 35V, -V_{CC} = -5V, V_{CM} = -15V$		-0.1	0.1	nA	1
				-10	50	nA	2
		$+V_{CC} = 5V, -V_{CC} = -25V, V_{CM} = 10V$		-0.1	0.3	nA	1
				-10	50	nA	2
$I_{IO}$	Input Offset Current			-0.02	0.02	nA	1
				-20	+20	nA	2
+PSRR	Power Supply Rejection Ratio	$+V_{CC} = 10V, -V_{CC} = -20V$		85		dB	1, 2, 3
-PSRR	Power Supply Rejection Ratio	$+V_{CC} = 20V, -V_{CC} = -10V$		85		dB	1, 2, 3
CMR	Input Voltage Common Mode Rejection	$V_{CM} = -15V$ to 15V		85		dB	1, 2, 3
$V_{IOAdj}(+)$	Adjustment for Input Offset Voltage			8.0		mV	1, 2, 3
$V_{IOAdj}(-)$	Adjustment for Input Offset Voltage				-8.0	mV	1, 2, 3
$+I_{OS}$	Output Short Circuit Current (For Positive Output)	$+V_{CC} = 15V, -V_{CC} = -15V, t \leq 25mS$		-50		mA	1, 2, 3
$-I_{OS}$	Output Short Circuit Current (For Negative Output)	$+V_{CC} = 15V, -V_{CC} = -15V, t \leq 25mS$			50	mA	1, 2, 3
$\Delta V_{IO}/\Delta T$	Temperature Coefficient of Input Offset Voltage	$25^\circ C \leq T_A \leq +125^\circ C$	See <sup>(1)</sup>	-30	30	$\mu V/^\circ C$	2
		$-55^\circ C \leq T_A \leq 25^\circ C$	See <sup>(1)</sup>	-30	30	$\mu V/^\circ C$	3
$-A_{VS}$	Open Loop Voltage Gain (Single Ended)	$V_O = -15V, R_L = 2K\Omega$	See <sup>(2)</sup>	50		V/mV	4
			See <sup>(2)</sup>	25		V/mV	5, 6
$+A_{VS}$	Open Loop Voltage Gain (Single Ended)	$V_O = +15V, R_L = 2K\Omega$	See <sup>(2)</sup>	50		V/mV	4
			See <sup>(2)</sup>	25		V/mV	5, 6
$A_{VS}$	Open Loop Voltage Gain (Single Ended)	$V_{CC} = \pm 5V, V_O = \pm 2V, R_L = 2K\Omega$	See <sup>(2)</sup>	10		V/mV	4, 5, 6
$-V_{OP}$	Output Voltage Swing	$V_{CM} = 20V, R_L = 10K\Omega$			-16	V	4, 5, 6
		$V_{CM} = 20V, R_L = 2K\Omega$			-15	V	4, 5, 6
$+V_{OP}$	Output Voltage Swing	$V_{CM} = -20V, R_L = 10K\Omega$		16		V	4, 5, 6
		$V_{CM} = -20V, R_L = 2K\Omega$		15		V	4, 5, 6

(1) Calculated parameter.  
 (2) Datalog Reading in K = V/mV.

## LF156 Electrical Characteristics AC Parameters

The following conditions apply, unless otherwise specified.

AC:  $V_{CC} = \pm 15V$ ,  $V_{CM} = 0V$

Symbol	Parameter	Conditions	Notes	Min	Max	Unit	Sub-groups
-SR	Slew Rate Fall	$V_I = 5V$ to $-5V$ , $A_V = 1$		7.5		V/ $\mu$ S	7
				5		V/ $\mu$ S	8A, 8B
+SR	Slew Rate Rise	$V_I = -5V$ to $5V$ , $A_V = 1$		7.5		V/ $\mu$ S	7
				5		V/ $\mu$ S	8A, 8B
TR <sub>TR</sub>	Transient Response Rise Time	$R_L = 2K\Omega$ , $C_L = 100pF$ , $V_I = 50mV$ , $A_V = 1$			100	nS	7, 8A, 8B
TR <sub>OS</sub>	Transient Response Overshoot	$R_L = 2K\Omega$ , $C_L = 100pF$ , $V_I = 50mV$ , $A_V = 1$			40	%	7, 8A, 8B
NI <sub>BB</sub>	Noise Broad Band	$BW = 5KHz$ , $V_{CC} = \pm 20V$			10	$\mu V_{RMS}$	7
NI <sub>PC</sub>	Noise Popcorn	$BW = 5KHz$ , $V_{CC} = \pm 20V$			40	$\mu V_{PK}$	7
tS (+)	Settling Time	$A_V = -1$			1500	nS	12
tS (-)	Settling Time	$A_V = -1$			1500	nS	12

## LF156 Electrical Characteristics Drift Values

The following conditions apply, unless otherwise specified.

AC:  $V_{CC} = \pm 20V$ ,  $V_{CM} = 0V$

Delta calculations performed on JAN S devices at group B, subgroup 5 only

Symbol	Parameter	Conditions	Notes	Min	Max	Unit	Sub-groups
V <sub>IO</sub>	Input Offset Voltage			-1.0	1.0	mV	1
$\pm I_B$	Input Bias Current			-0.05	0.05	nA	1

Typical DC Performance Characteristics

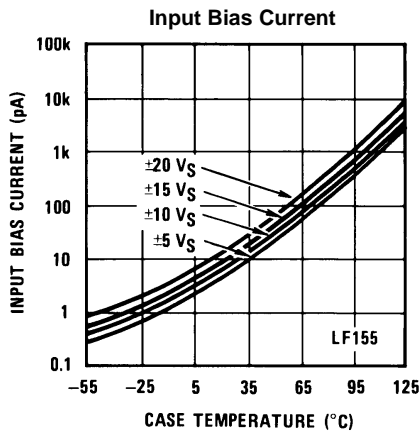


Figure 2.

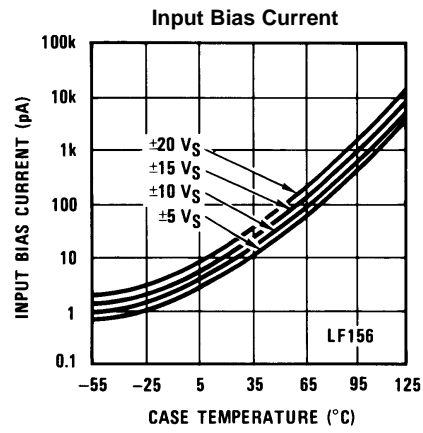


Figure 3.

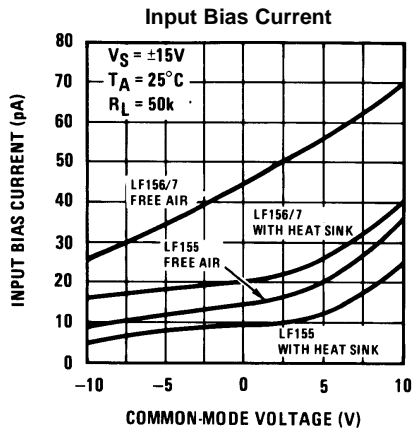


Figure 4.

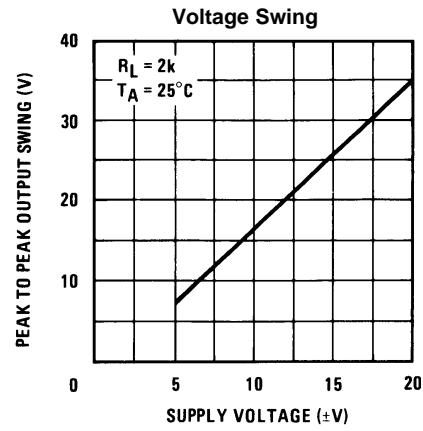


Figure 5.

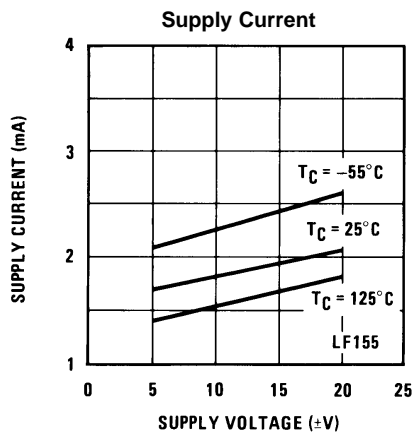


Figure 6.

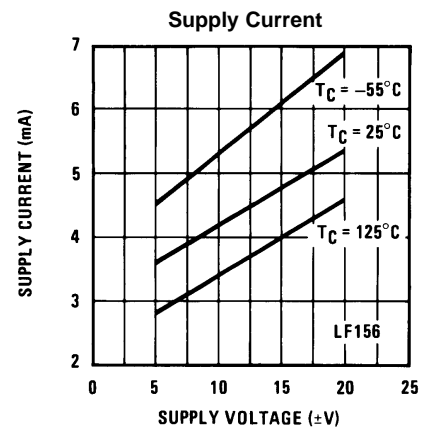


Figure 7.

Typical DC Performance Characteristics (continued)

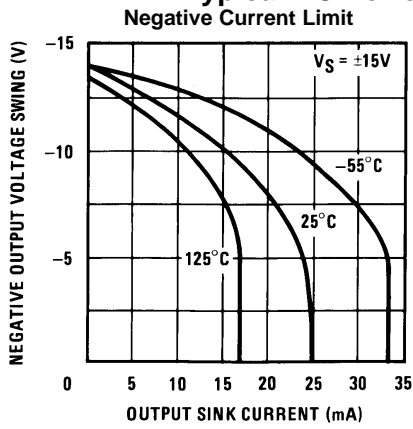


Figure 8.

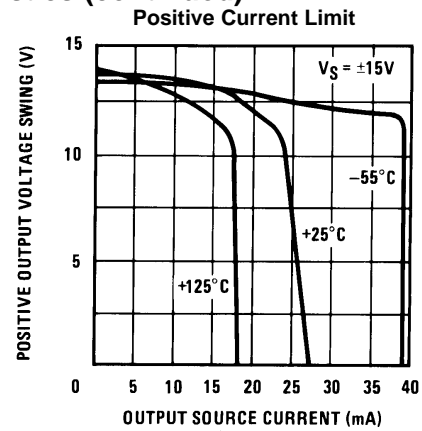


Figure 9.

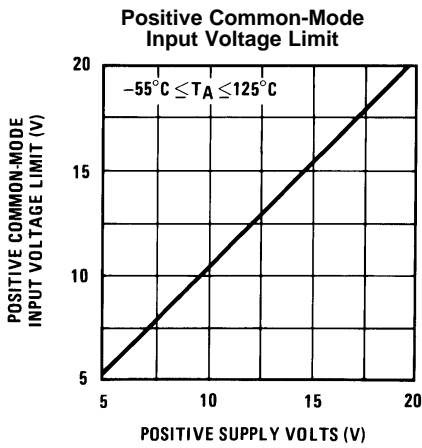


Figure 10.

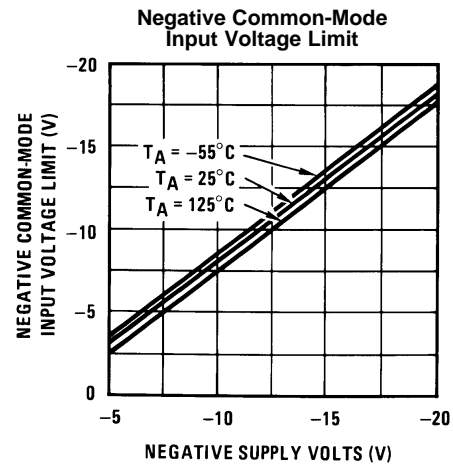


Figure 11.

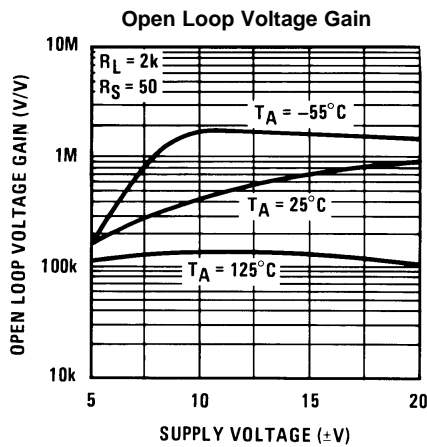


Figure 12.

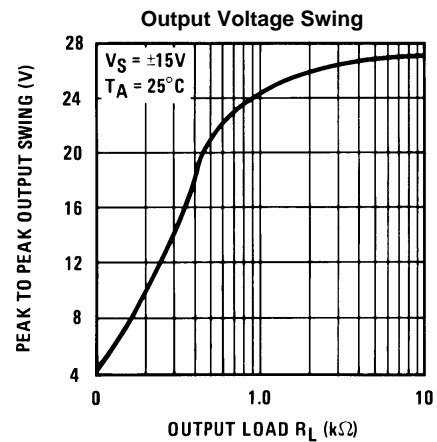


Figure 13.

Typical AC Performance Characteristics

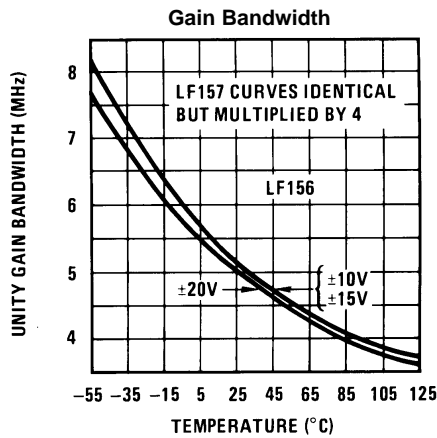


Figure 14.

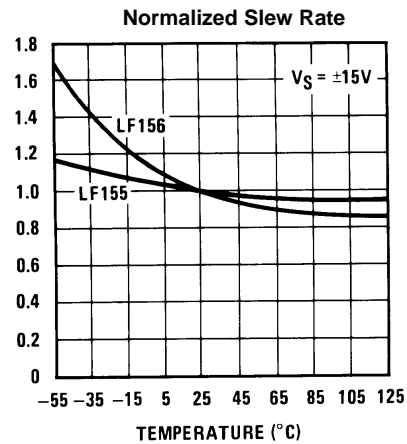


Figure 15.

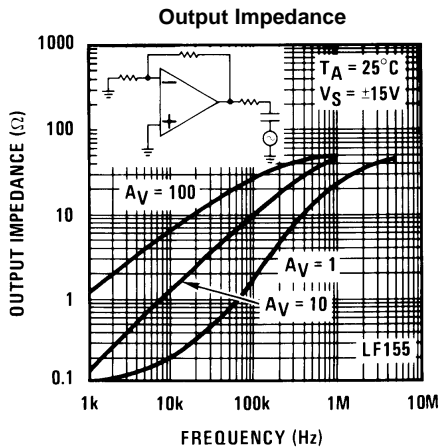


Figure 16.

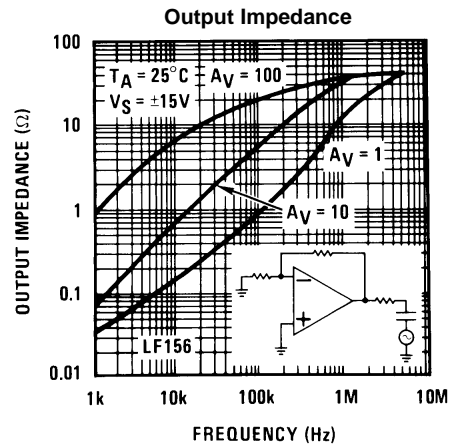


Figure 17.

LF156 Small Signal Pulse Response, AV = +1

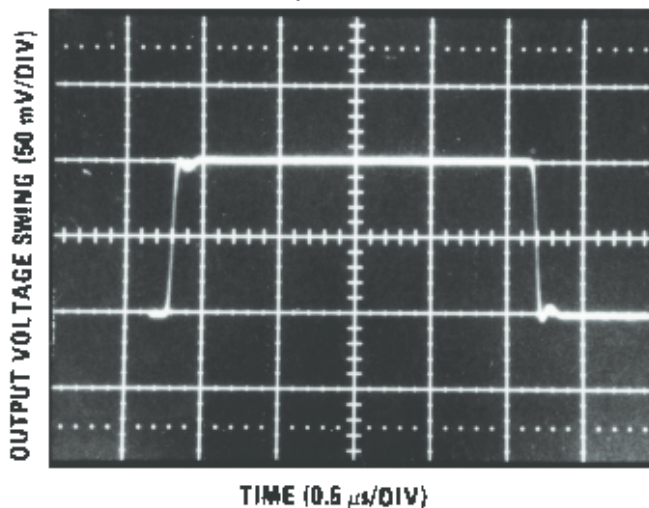


Figure 18.

LF156 Large Signal Puls Response, AV = +1

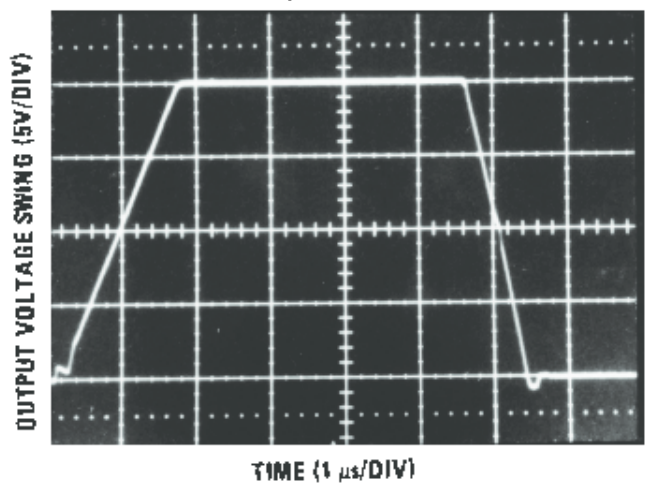


Figure 19.



Typical AC Performance Characteristics (continued)

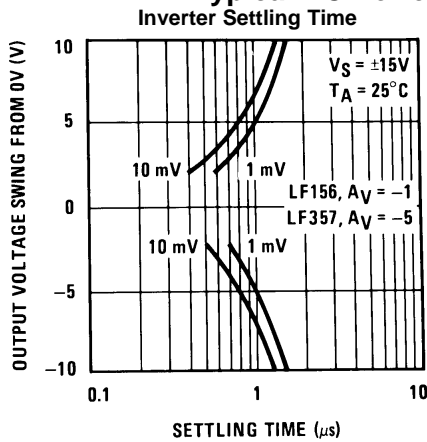


Figure 20.

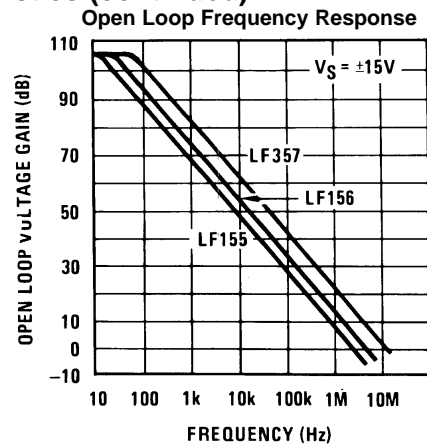


Figure 21.

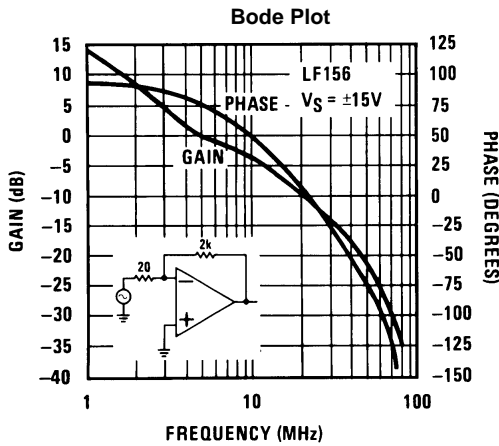


Figure 22.

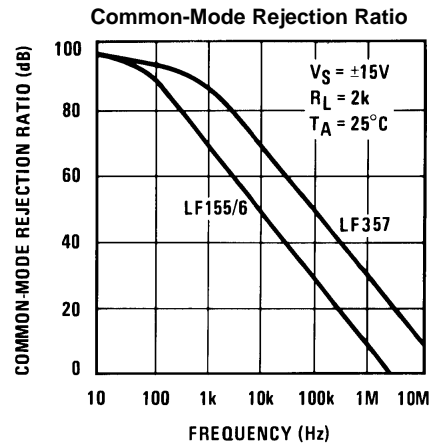


Figure 23.

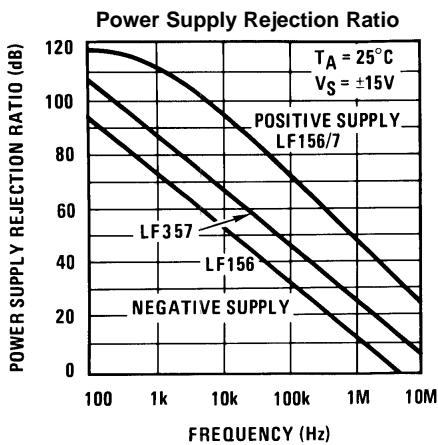


Figure 24.

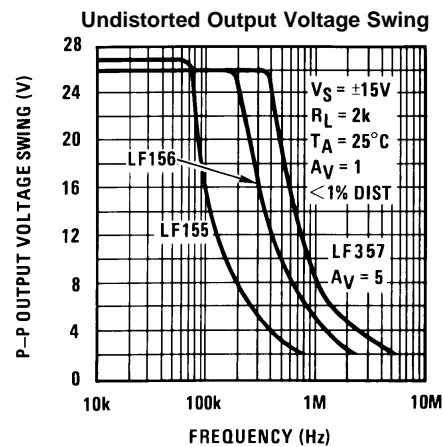


Figure 25.

Typical AC Performance Characteristics (continued)

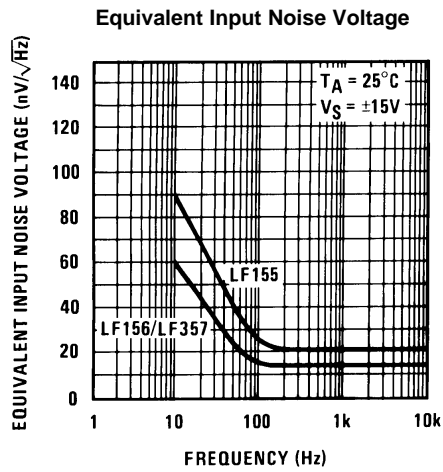


Figure 26.

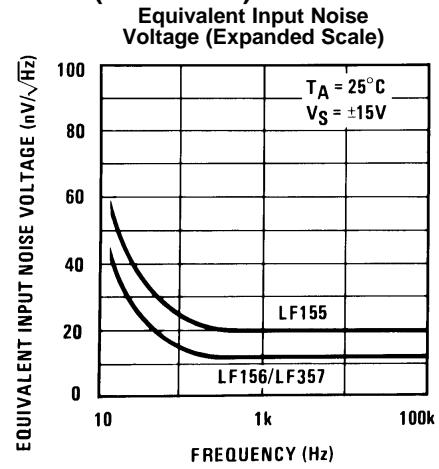


Figure 27.

## APPLICATION HINTS

These are op amps with JFET input devices. These JFETs have large reverse breakdown voltages from gate to source and drain eliminating the need for clamps across the inputs. Therefore large differential input voltages can easily be accommodated without a large increase in input current. The maximum differential input voltage is independent of the supply voltages. However, neither of the input voltages should be allowed to exceed the negative supply as this will cause large currents to flow which can result in a destroyed unit.

Exceeding the negative common-mode limit on either input will force the output to a high state, potentially causing a reversal of phase to the output. Exceeding the negative common-mode limit on both inputs will force the amplifier output to a high state. In neither case does a latch occur since raising the input back within the common-mode range again puts the input stage and thus the amplifier in a normal operating mode.

Exceeding the positive common-mode limit on a single input will not change the phase of the output however, if both inputs exceed the limit, the output of the amplifier will be forced to a high state.

These amplifiers will operate with the common-mode input voltage equal to the positive supply. In fact, the common-mode voltage can exceed the positive supply by approximately 100 mV independent of supply voltage and over the full operating temperature range. The positive supply can therefore be used as a reference on an input as, for example, in a supply current monitor and/or limiter.

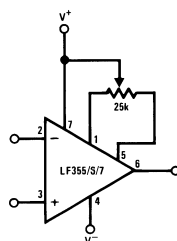
Precautions should be taken to ensure that the power supply for the integrated circuit never becomes reversed in polarity or that the unit is not inadvertently installed backwards in a socket as an unlimited current surge through the resulting forward diode within the IC could cause fusing of the internal conductors and result in a destroyed unit.

All of the bias currents in these amplifiers are set by FET current sources. The drain currents for the amplifiers are therefore essentially independent of supply voltage.

As with most amplifiers, care should be taken with lead dress, component placement and supply decoupling in order to ensure stability. For example, resistors from the output to an input should be placed with the body close to the input to minimize “pickup” and maximize the frequency of the feedback pole by minimizing the capacitance from the input to ground.

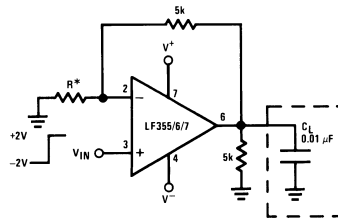
A feedback pole is created when the feedback around any amplifier is resistive. The parallel resistance and capacitance from the input of the device (usually the inverting input) to AC ground set the frequency of the pole. In many instances the frequency of this pole is much greater than the expected 3dB frequency of the closed loop gain and consequently there is negligible effect on stability margin. However, if the feedback pole is less than approximately six times the expected 3 dB frequency a lead capacitor should be placed from the output to the input of the op amp. The value of the added capacitor should be such that the RC time constant of this capacitor and the resistance it parallels is greater than or equal to the original feedback pole time constant.

### Typical Circuit Connections



**Figure 28.  $V_{OS}$  Adjustment**

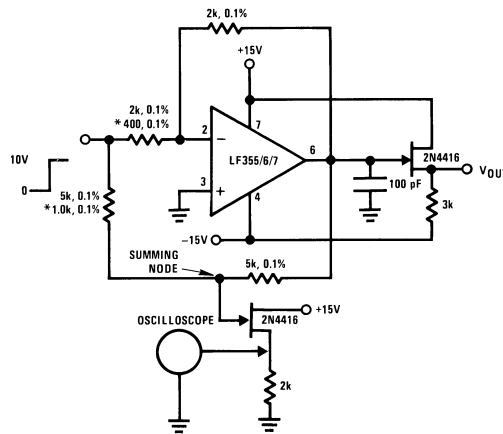
- $V_{OS}$  is adjusted with a 25k potentiometer
- The potentiometer wiper is connected to  $V^+$
- For potentiometers with temperature coefficient of 100 ppm/°C or less the additional drift with adjust is  $\approx 0.5\mu\text{V}/^\circ\text{C}/\text{mV}$  of adjustment
- Typical overall drift:  $5\mu\text{V}/^\circ\text{C} \pm(0.5\mu\text{V}/^\circ\text{C}/\text{mV}$  of adj.)



**Figure 29. Driving Capacitive Loads**

- \* LF156 R = 5k  
 Due to a unique output stage design, these amplifiers have the ability to drive large capacitive loads and still maintain stability.  $C_{L(MAX)} \approx 0.01\mu F$ .  
 Overshoot  $\leq 20\%$   
 Settling time ( $t_s$ )  $\approx 5\mu s$

**Typical Applications**



**Figure 30. Settling Time Test Circuit**

- Settling time is tested with the LF156 connected as unity gain inverter.
- FET used to isolate the probe capacitance
- Output = 10V step

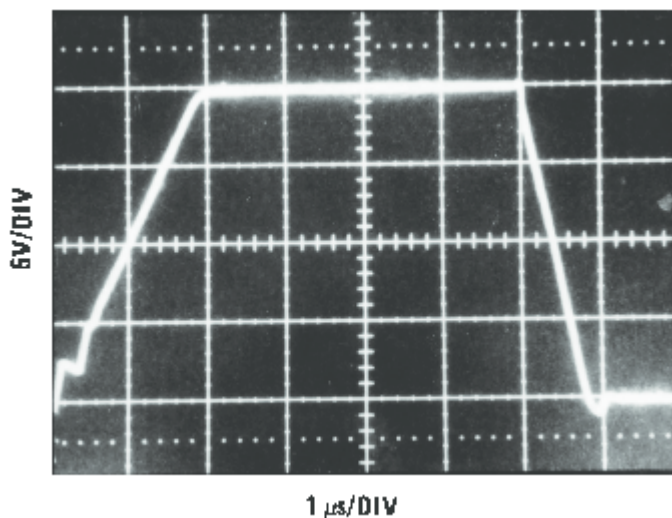


Figure 31. Large Signal Inverter Output,  $V_{OUT}$  (from Settling Time Circuit) LF356

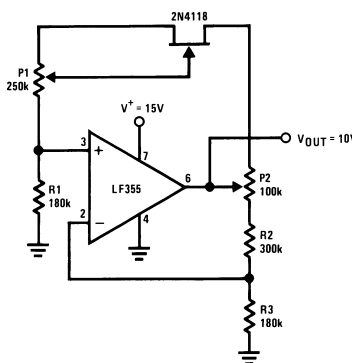


Figure 32. Low Drift Adjustable Voltage Reference

- $\Delta V_{OUT}/\Delta T = \pm 0.002\%/^{\circ}\text{C}$
- All resistors and potentiometers should be wire-wound
- P1: drift adjust
- P2:  $V_{OUT}$  adjust

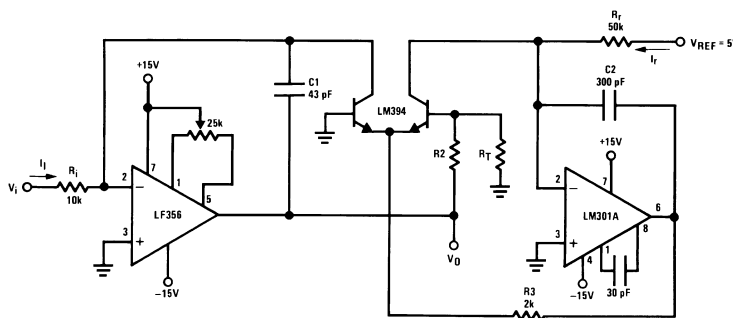


Figure 33. Fast Logarithmic Converter

- Dynamic range:  $100\mu\text{A} \leq I_i \leq 1\text{mA}$  (5 decades),  $|V_O| = 1\text{V/decade}$
- Transient response:  $3\mu\text{s}$  for  $\Delta I_i = 1$  decade

- C1, C2, R2, R3: added dynamic compensation
- $V_{OS}$  adjust the LF156 to minimize quiescent error
- $R_T$ : Tel Labs type Q81 + 0.3%/°C

$$|V_{OUT}| = \left[ 1 + \frac{R_2}{R_T} \right] \frac{kT}{q} \ln V_i \left[ \frac{R_T}{V_{REF} R_i} \right] = \log V_i \frac{1}{R_i I_r} \quad R_2 = 15.7k, R_T = 1k, 0.3\%/^{\circ}C \quad (1)$$

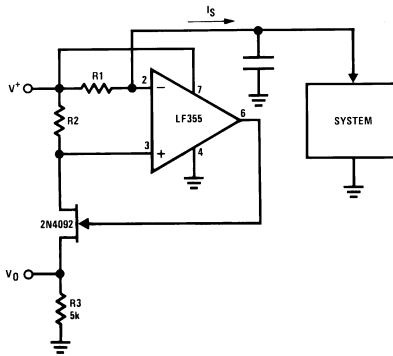


Figure 34. Precision Current Monitor

- $V_O = 5 R_1/R_2$  (V/mA of  $I_S$ )
- R1, R2, R3: 0.1% resistors

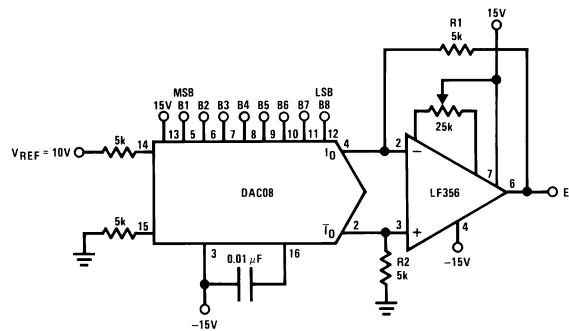
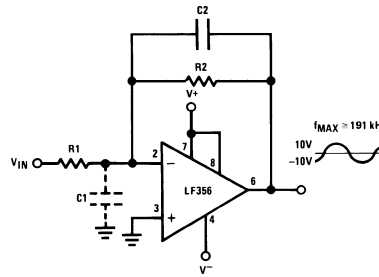


Figure 35. 8-Bit D/A Converter with Symmetrical Offset Binary Operation

- R1, R2 should be matched within  $\pm 0.05\%$
- Full-scale response time: 3μs

$E_O$	B1	B2	B3	B4	B5	B6	B7	B8	Comments
+9.920	1	1	1	1	1	1	1	1	Positive Full-Scale
+0.040	1	0	0	0	0	0	0	0	(+) Zero-Scale
-0.040	0	1	1	1	1	1	1	1	(-) Zero-Scale
-9.920	0	0	0	0	0	0	0	0	Negative Full-Scale



• Power BW:  $f_{MAX} = \frac{S_r}{2\pi V_p} \cong 191 \text{ kHz}$

Figure 36. Wide BW Low Noise, Low Drift Amplifier

- Parasitic input capacitance  $C_1 \approx 3\text{pF}$  interacts with feedback elements and creates undesirable high frequency pole. To compensate add  $C_2$  such that:  $R_2 C_2 \approx R_1 C_1$ .

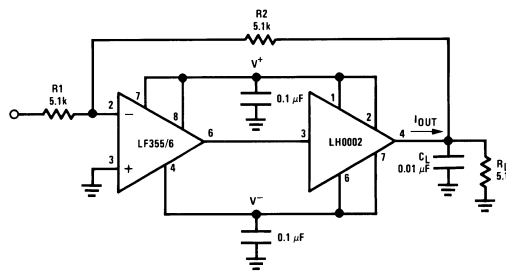
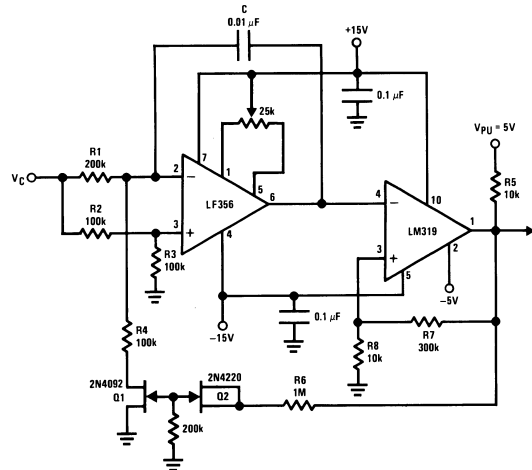


Figure 37. Boosting the LF156 with a Current Amplifier

- $I_{OUT(MAX)} \approx 150\text{mA}$  (will drive  $R_L \geq 100\Omega$ )
- $\frac{\Delta V_{OUT}}{\Delta T} = \frac{0.15}{10^{-2}} \text{ V}/\mu\text{s}$  (with  $C_L$  shown)
- No additional phase shift added by the current amplifier



$$f = \frac{V_C (R_8 + R_7)}{(8 V_{PU} R_8 R_1) C'} \quad 0 \leq V_C \leq 30\text{V}, \quad 10 \text{ Hz} \leq f \leq 10 \text{ kHz}$$

R1, R4 matched. Linearity 0.1% over 2 decades.

Figure 38. 3 Decades VCO

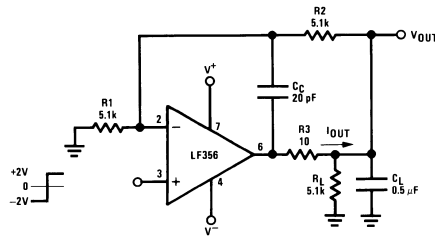


Figure 39. Isolating Large Capacitive Loads

- Overshoot 6%
- $t_s$  10 $\mu$ s
- When driving large  $C_L$ , the  $V_{OUT}$  slew rate determined by  $C_L$  and  $I_{OUT(MAX)}$ :

$$\frac{\Delta V_{OUT}}{\Delta T} = \frac{I_{OUT}}{C_L} \cong \frac{0.02}{0.5} V/\mu s = 0.04 V/\mu s \text{ (with } C_L \text{ shown)} \tag{2}$$

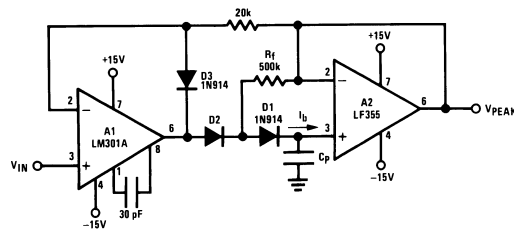
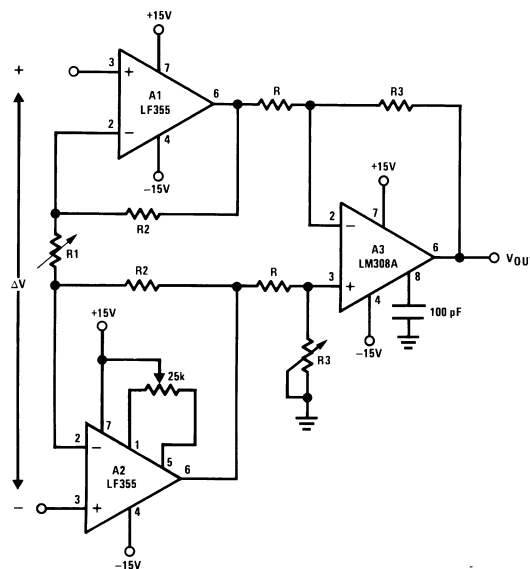


Figure 40. Low Drift Peak Detector

- By adding D1 and  $R_f$ ,  $V_{D1}=0$  during hold mode. Leakage of D2 provided by feedback path through  $R_f$ .
- Leakage of circuit is essentially  $I_b$  plus capacitor leakage of  $C_p$ .
- Diode D3 clamps  $V_{OUT}$  (A1) to  $V_{IN}-V_{D3}$  to improve speed and to limit reverse bias of D2.
- Maximum input frequency should be  $\ll \frac{1}{2}\pi R_f C_{D2}$  where  $C_{D2}$  is the shunt capacitance of D2.



$$V_{OUT} = \frac{R3}{R} \left[ \frac{2R2}{R1} + 1 \right] \Delta V, V^- + 2V \leq V_{IN} \text{ common-mode} \leq V^+$$

Figure 41. High Impedance, Low Drift Instrumentation Amplifier

- System  $V_{OS}$  adjusted via A2  $V_{OS}$  adjust



- Trim R3 to boost up CMRR to 120 dB. Instrumentation amplifier resistor array recommended for best accuracy and lowest drift

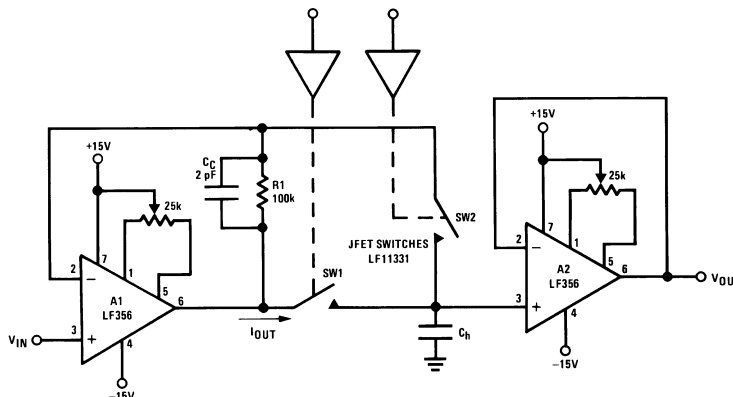


Figure 42. Fast Sample and Hold

- Both amplifiers (A1, A2) have feedback loops individually closed with stable responses (overshoot negligible)
- Acquisition time  $T_A$ , estimated by:

$$T_A \cong \left[ \frac{2R_{ON}, V_{IN}, C_h}{S_r} \right]^{1/2} \text{ provided that:}$$

$$V_{IN} < 2\pi S_r R_{ON} C_h \text{ and } T_A > \frac{V_{IN} C_h}{I_{OUT(MAX)}}, R_{ON} \text{ is of SW1}$$

$$\text{If inequality not satisfied: } T_A \cong \frac{V_{IN} C_h}{20 \text{ mA}}$$

(3)

- LF156 develops full  $S_r$  output capability for  $V_{IN} \geq 1V$
- Addition of SW2 improves accuracy by putting the voltage drop across SW1 inside the feedback loop
- Overall accuracy of system determined by the accuracy of both amplifiers, A1 and A2

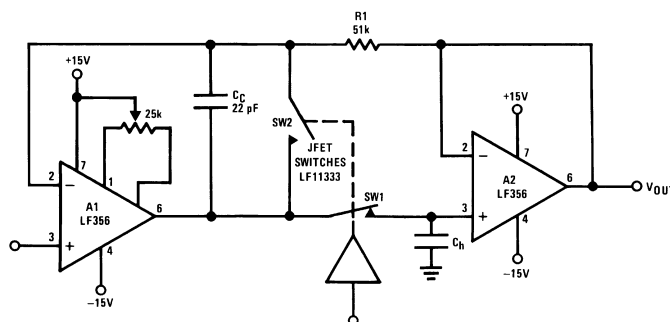
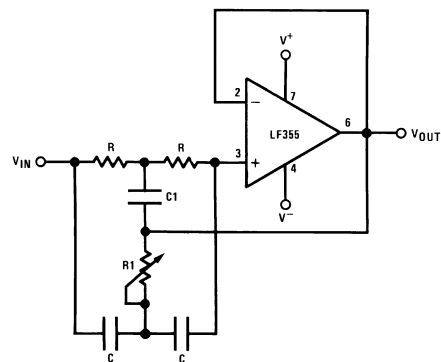


Figure 43. High Accuracy Sample and Hold

- By closing the loop through A2, the  $V_{OUT}$  accuracy will be determined uniquely by A1.
  - No  $V_{OS}$  adjust required for A2.
- $T_A$  can be estimated by same considerations as previously but, because of the added
  - propagation delay in the feedback loop (A2) the overshoot is not negligible.
- Overall system slower than fast sample and hold
- R1, Cc: additional compensation
- Use LF156 for
  - Fast settling time
  - Low  $V_{OS}$



**Figure 44. High Q Notch Filter**

- $2R1 = R = 10M\Omega$ 
  - $2C = C1 = 300pF$
- Capacitors should be matched to obtain high Q
- $f_{NOTCH} = 120\text{ Hz}$ , notch = -55 dB,  $Q > 100$
- Use LF155 for
  - Low  $I_B$
  - Low supply current

### REVISION HISTORY

Date Released	Revision	Section	Originator	Changes
03/10/06	A	New Released, Corporate format.	R. Malone	New Release, Corporate format 1 MDS data sheet converted into a Corp. data sheet format. Following MDS data sheet will be Archived MJLF156-X, Rev. 0A0.
03/25/13	A	All	-	Changed layout of National Data Sheet to TI format.

**PACKAGING INFORMATION**

Orderable part number	Status (1)	Material type (2)	Package   Pins	Package qty   Carrier	RoHS (3)	Lead finish/ Ball material (4)	MSL rating/ Peak reflow (5)	Op temp (°C)	Part marking (6)
JL156BGA	Active	Production	TO-99 (LMC)   8	20   JEDEC TRAY (5+1)	Yes	Call TI	Level-1-NA-UNLIM	-55 to 125	JL156BGA JM38510/11402BGA Q ACO JM38510/11402BGA Q >T
JM38510/11402BGA	Active	Production	TO-99 (LMC)   8	20   JEDEC TRAY (5+1)	Yes	Call TI	Level-1-NA-UNLIM	-55 to 125	JL156BGA JM38510/11402BGA Q ACO JM38510/11402BGA Q >T
M38510/11402BGA	Active	Production	TO-99 (LMC)   8	20   JEDEC TRAY (5+1)	Yes	Call TI	Level-1-NA-UNLIM	-55 to 125	JL156BGA JM38510/11402BGA Q ACO JM38510/11402BGA Q >T

(1) **Status:** For more details on status, see our [product life cycle](#).

(2) **Material type:** When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

(3) **RoHS values:** Yes, No, RoHS Exempt. See the [TI RoHS Statement](#) for additional information and value definition.

(4) **Lead finish/Ball material:** Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

(5) **MSL rating/Peak reflow:** The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

(6) **Part marking:** There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

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**TRAY**


Chamfer on Tray corner indicates Pin 1 orientation of packed units.

\*All dimensions are nominal

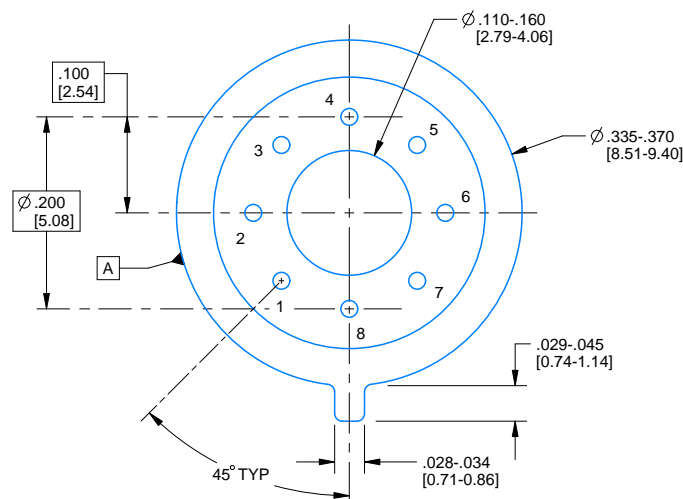
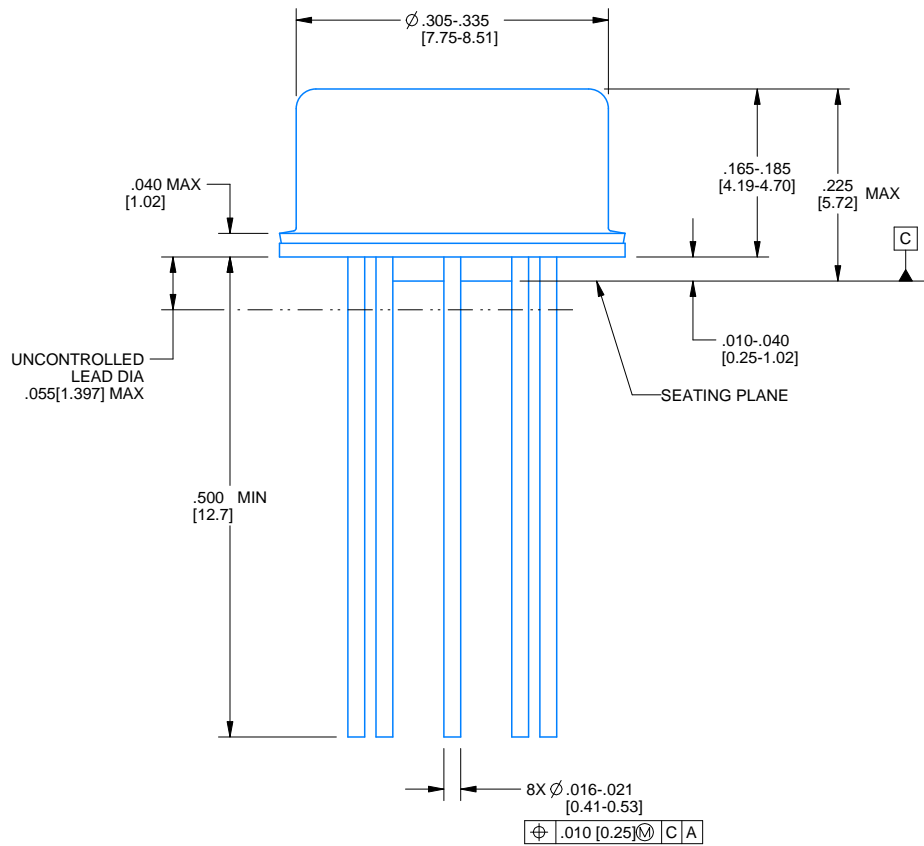
Device	Package Name	Package Type	Pins	SPQ	Unit array matrix	Max temperature (°C)	L (mm)	W (mm)	K0 (µm)	P1 (mm)	CL (mm)	CW (mm)
JL156BGA	LMC	TO-CAN	8	20	2 X 10	150	126.49	61.98	8890	11.18	12.95	18.54
JM38510/11402BGA	LMC	TO-CAN	8	20	2 X 10	150	126.49	61.98	8890	11.18	12.95	18.54
M38510/11402BGA	LMC	TO-CAN	8	20	2 X 10	150	126.49	61.98	8890	11.18	12.95	18.54

# PACKAGE OUTLINE

## LMC0008A

### TO-CAN - 5.72 mm max height

TRANSISTOR OUTLINE



4220610/B 09/2024

#### NOTES:

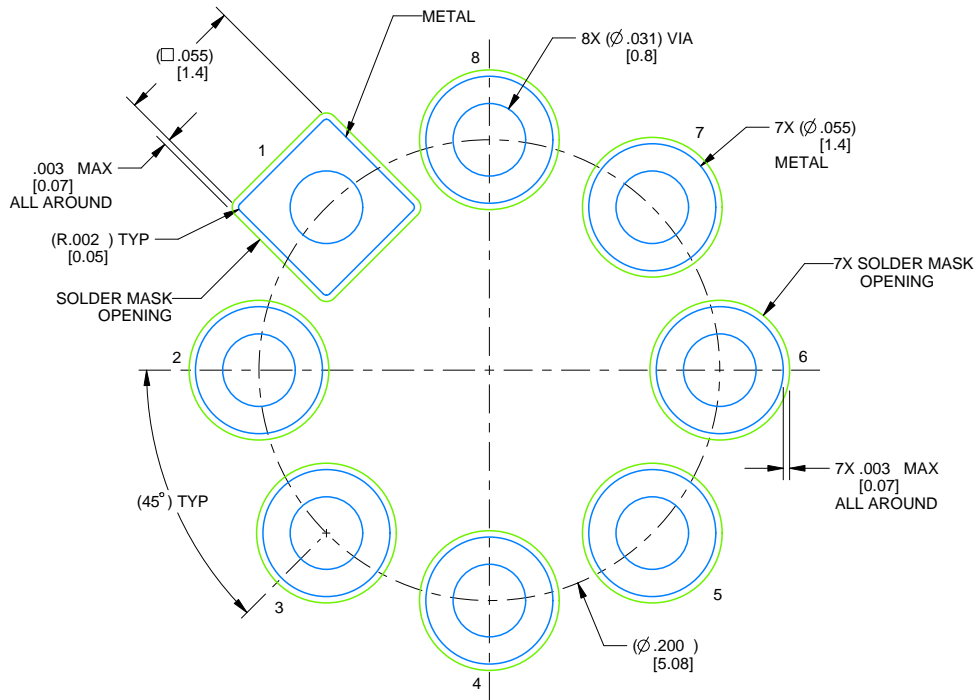
1. All linear dimensions are in inches [millimeters]. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. Pin numbers shown for reference only. Numbers may not be marked on package.
4. Reference JEDEC registration MO-002/TO-99.

# EXAMPLE BOARD LAYOUT

## LMC0008A

### TO-CAN - 5.72 mm max height

TRANSISTOR OUTLINE



LAND PATTERN EXAMPLE  
NON-SOLDER MASK DEFINED  
SCALE: 12X

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